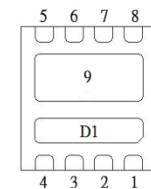
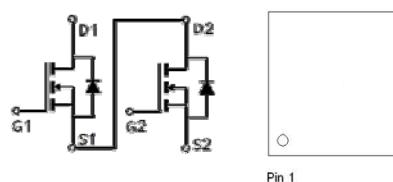


NIKO-SEM
**Dual N-Channel Enhancement Mode
Field Effect Transistor**
PE618DT
PDFN 3x3S
Halogen-Free & Lead-Free
PRODUCT SUMMARY

	$V_{(BR)DSS}$	$R_{DS(ON)}$	I_D
Q2	30V	7mΩ	39
Q1	30V	16mΩ	23


 1 : G1
 2,3,4 : D1
 5,6,7 : S2
 8 : G2
 9 : S1/D2
ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	Q2	Q1	UNITS
Drain-Source Voltage		V_{DS}	30	30	V
Gate-Source Voltage		V_{GS}	± 20	± 20	V
Continuous Drain Current ³	$T_C = 25^\circ\text{C}$	I_D	39	23	A
	$T_C = 100^\circ\text{C}$		25	14	
Pulsed Drain Current ¹		I_{DM}	50	32	
Continuous Drain Current	$T_A = 25^\circ\text{C}$	I_D	12	7.3	W
	$T_A = 70^\circ\text{C}$		10	5.8	
Avalanche Current		I_{AS}	23	12	
Avalanche Energy	$L = 0.1\text{mH}$	E_{AS}	26	7	mJ
Power Dissipation	$T_C = 25^\circ\text{C}$	P_D	20	16	W
	$T_C = 100^\circ\text{C}$		8.3	6	
Power Dissipation	$T_A = 25^\circ\text{C}$	P_D	2.2	1.6	W
	$T_A = 70^\circ\text{C}$		1.4	1	
Operating Junction & Storage Temperature Range		T_j, T_{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Ambient ²	$R_{\theta JA}$	Q2	56	°C / W
	$R_{\theta JA}$	Q1	77	
Junction-to-Case	$R_{\theta JC}$	Q2	6	
	$R_{\theta JC}$	Q1	7.5	

¹Pulse width limited by maximum junction temperature $T_{J(MAX)}=150^\circ\text{C}$.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$. The value in any given application depends on the user's specific board design.

³Package limitation current is Q2=19A , Q1=11A.

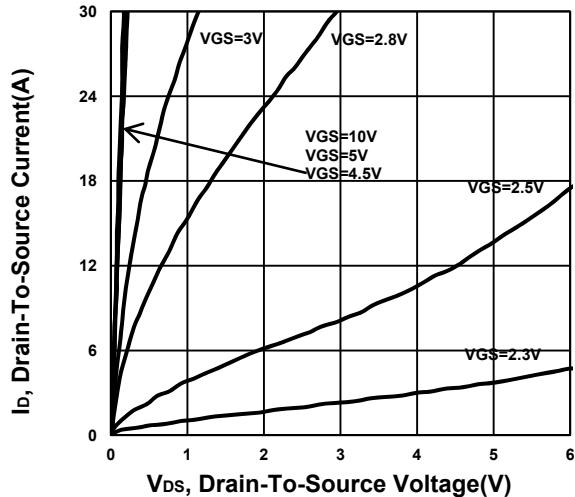
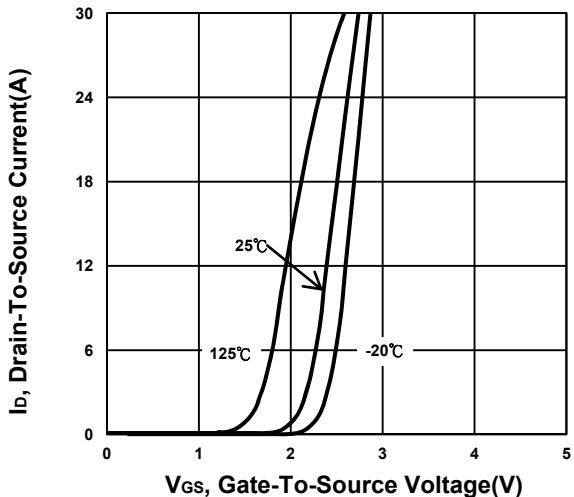
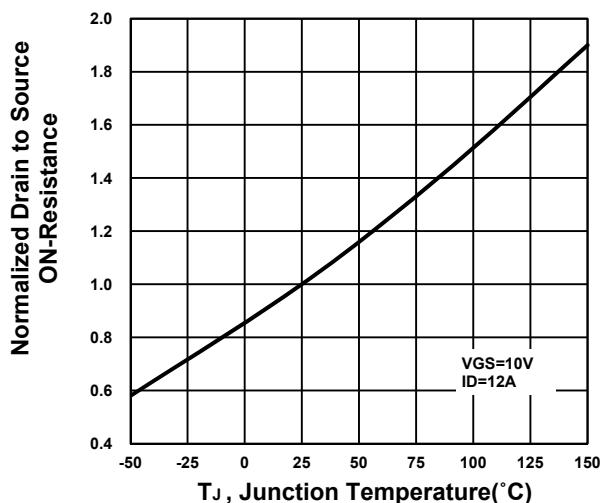
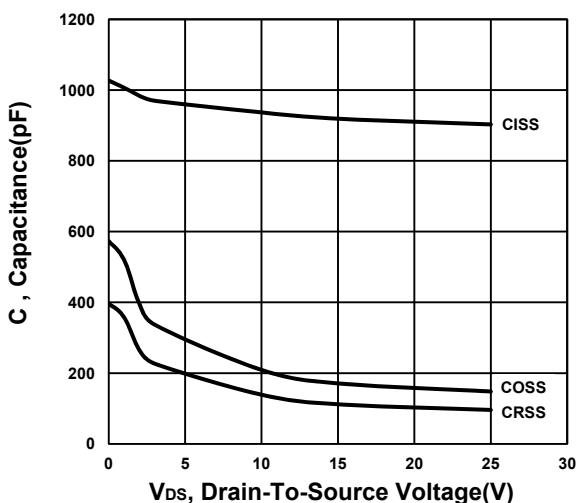
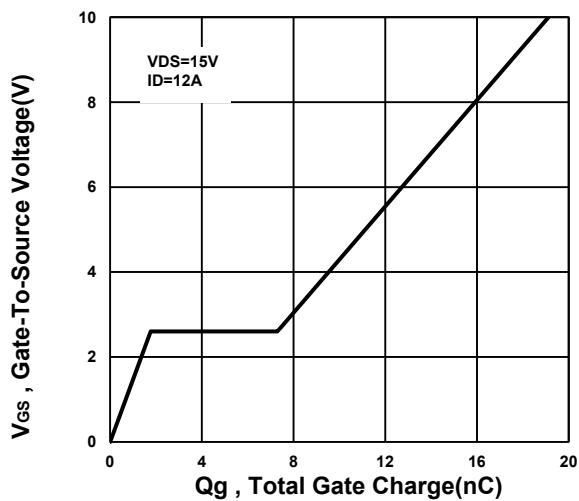
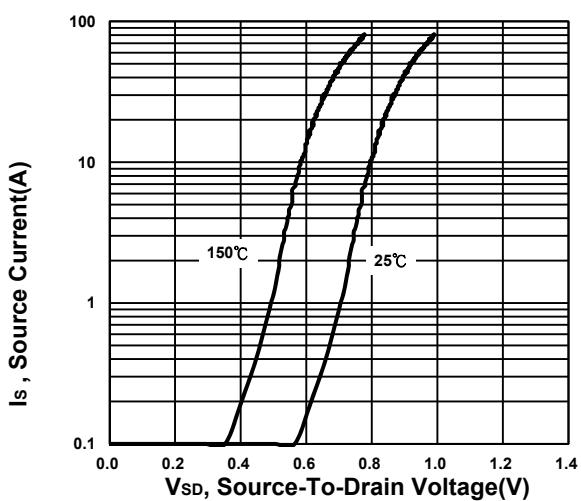
NIKO-SEM
**Dual N-Channel Enhancement Mode
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PE618DT
PDFN 3x3S
Halogen-Free & Lead-Free
ELECTRICAL CHARACTERISTICS (T_J = 25 °C, Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT	
			MIN	TYP	MAX		
STATIC							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250µA	Q2	30			
			Q1	30			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250µA	Q2	1.3	1.75	2.3	
			Q1	1.3	1.75	2.3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0V, V _{GS} = ±20V	Q2		±100		
			Q1		±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 24V, V _{GS} = 0V	Q2		1		
			Q1		1		
		V _{DS} = 20V, V _{GS} = 0V, T _J = 55 °C	Q2		10		
			Q1		10		
Drain-Source On-State Resistance ¹	R _{DS(ON)}	V _{GS} = 4.5V, I _D = 10A	Q2		7	9.5	
		V _{GS} = 4.5V, I _D = 6A	Q1		19.4	24	
		V _{GS} = 10V, I _D = 12A	Q2		5.4	7	
		V _{GS} = 10V, I _D = 7A	Q1		13	16	
Forward Transconductance ¹	g _{fs}	V _{DS} = 5V, I _D = 12A	Q2		55		
		V _{DS} = 5V, I _D = 7A	Q1		34		
DYNAMIC							
Input Capacitance	C _{iss}	V _{GS} = 0V, V _{DS} = 15V, f = 1MHz	Q2		941		
			Q1		331		
Output Capacitance	C _{oss}		Q2		172		
			Q1		71		
Reverse Transfer Capacitance	C _{rss}		Q2		118		
			Q1		48		
Total Gate Charge ²	Q _g	V _{GS} = 10V V _{GS} = 4.5V	Q2		21		
			Q1		8		
			Q2		14		
			Q1		4.4		
Gate-Source Charge ²	Q _{gs}	V _{DS} = 15V, V _{GS} = 10V, I _D = 12A V _{DS} = 15V, V _{GS} = 10V, I _D = 7A	Q2		2		
			Q1		1.2		
Gate-Drain Charge ²	Q _{gd}		Q2		7		
			Q1		2.3		

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Turn-On Delay Time ²	$t_{d(on)}$	Q2 $V_{DS} = 15V$, $I_D \cong 12A$, $V_{GS} = 10V$, $R_{GEN} = 6\Omega$ Q1 $V_{DS} = 15V$, $I_D \cong 7A$, $V_{GS} = 10V$, $R_{GEN} = 6\Omega$	Q2		28		nS
Rise Time ²	t_r		Q1		17		
Turn-Off Delay Time ²	$t_{d(off)}$		Q2		23.8		
Fall Time ²	t_f		Q1		17		
			Q2		51		
			Q1		37		
			Q2		25		
			Q1		18		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J = 25^\circ C$)							
Continuous Current ³	I_S		Q2			16	A
			Q1			11.4	
Forward Voltage ¹	V_{SD}	$I_F = 12A$, $V_{GS} = 0V$	Q2			1.2	V
		$I_F = 7A$, $V_{GS} = 0V$	Q1			1.4	
Reverse Recovery Time	t_{rr}	Q2 $I_F = 12A$, $dI_F/dt = 100A/\mu S$ Q1 $I_F = 7A$, $dI_F/dt = 100A/\mu S$	Q2		16		nS
			Q1		8.8		
Reverse Recovery Charge	Q_{rr}		Q2		7		
			Q1		2.3		

¹Pulse test : Pulse Width $\leq 300 \mu sec$, Duty Cycle $\leq 2\%$.²Independent of operating temperature.³Package limitation current is Q2=19A , Q1=11A.

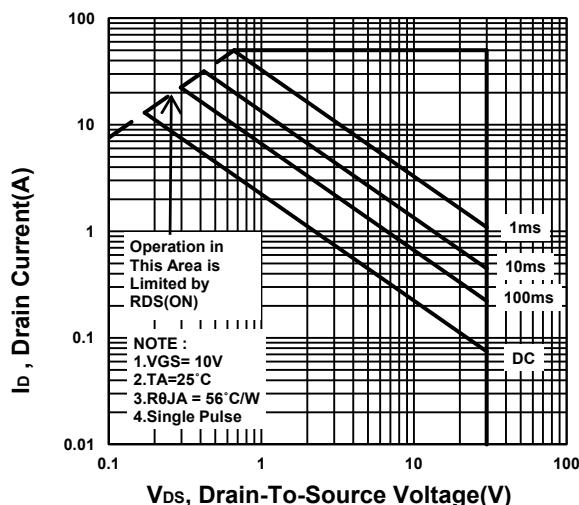
NIKO-SEM**Dual N-Channel Enhancement Mode
Field Effect Transistor****PE618DT**
PDFN 3x3S
Halogen-Free & Lead-Free**Q2 – Channel : Typical Characteristics****Output Characteristics****Transfer Characteristics****On-Resistance VS Temperature****Capacitance Characteristic****Gate charge Characteristics****Source-Drain Diode Forward Voltage**

NIKO-SEM

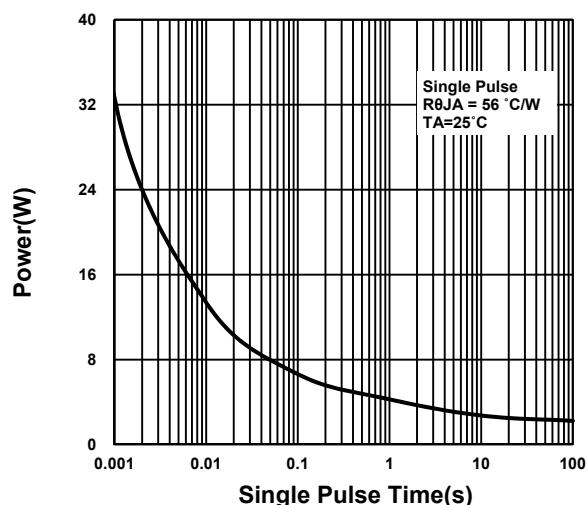
**Dual N-Channel Enhancement Mode
Field Effect Transistor**

PE618DT
PDFN 3x3S
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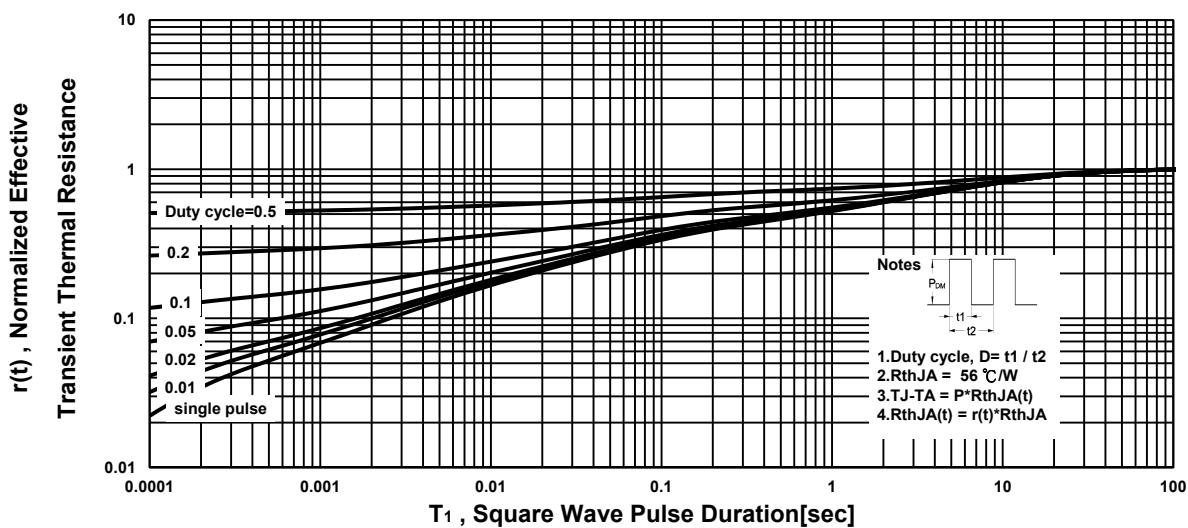
Safe Operating Area

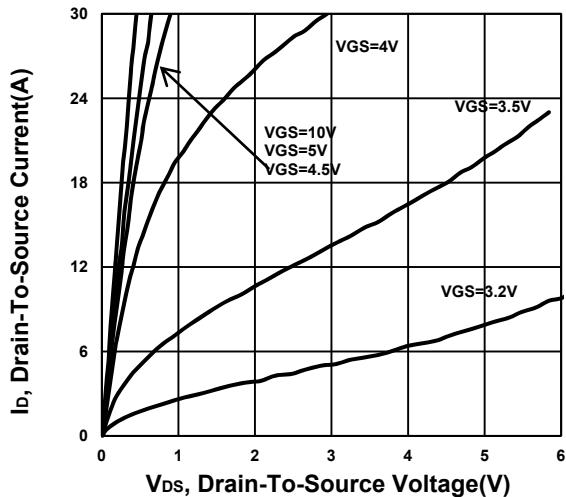
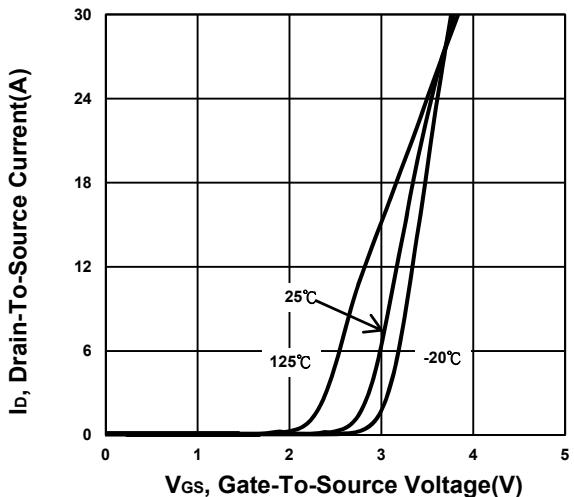
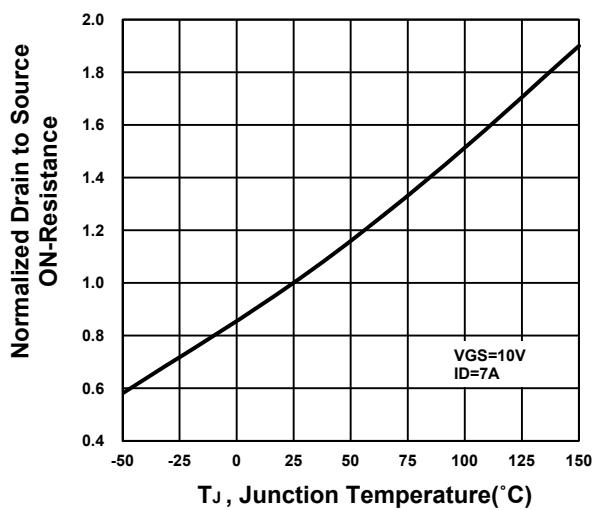
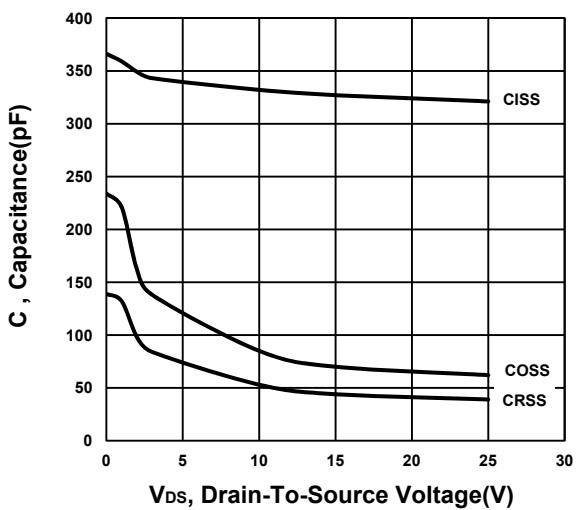
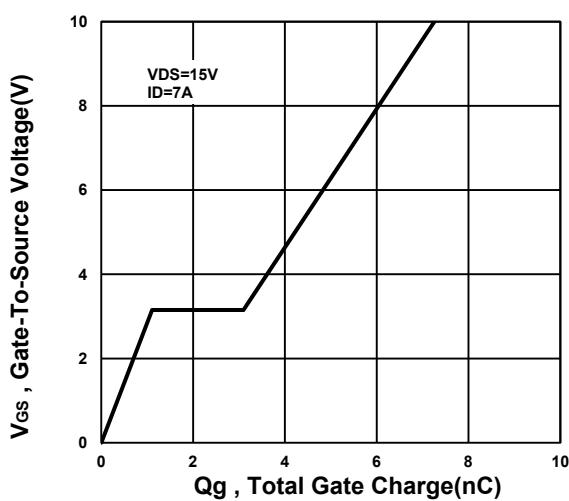
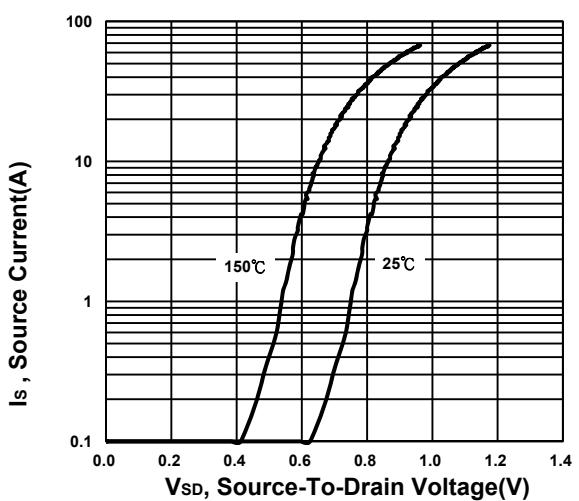


Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve



NIKO-SEM**Dual N-Channel Enhancement Mode
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PDFN 3x3S
Halogen-Free & Lead-Free****Q1 – Channel : Typical Characteristics****Output Characteristics****Transfer Characteristics****On-Resistance VS Temperature****Capacitance Characteristic****Gate charge Characteristics****Source-Drain Diode Forward Voltage**

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Field Effect Transistor**

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